## **SIEMENS**

## **Data sheet**

## 6DL1193-6GC00-0NN0



SIMATIC ET 200SP HA, carrier module 8-fold carrier for holding 8 I/O modules of the ET 200SP HA  $\,$ 

Figure similar

General information	
Product type designation	Carrier module 8 times
Product function	
• I&M data	Yes; Asset data
Hardware configuration	
Formation of potential groups	
<ul> <li>support of potential groups</li> </ul>	Yes
Slots	
<ul> <li>Number of slots</li> </ul>	8
Potential separation	
between backplane bus and supply voltage	Yes; 4 200 V DC/1 min, type test
between the potential groups	Yes; 3 510 V AC/ 5 s, type test (between the power supply groups; due to isolating distance (increased isolation) for future ÜK-III requirement of F technology)
Isolation	
Isolation tested with	1 500 V DC/1 min, type test (between backplane bus and functional ground)
Ambient conditions	
Ambient temperature during operation	
<ul> <li>horizontal installation, min.</li> </ul>	-40 °C
<ul> <li>horizontal installation, max.</li> </ul>	70 °C
<ul> <li>vertical installation, min.</li> </ul>	-40 °C
<ul> <li>vertical installation, max.</li> </ul>	60 °C
Dimensions	
Width	187.5 mm; 180 mm when installed
Height	203 mm
Depth	79 mm
Weights	
Weight, approx.	450 g

last modified: 3/12/2021 🖸